



STEIF POWER  
TECHNOLOGY

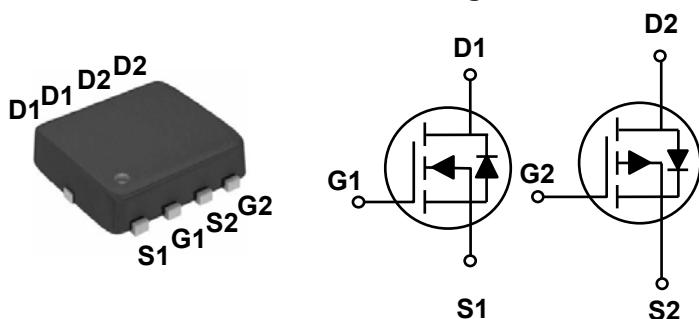
30V N+P Dual Channel MOSFETs

SPC3712V

## General Description

These N+P dual Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

## PPAK3X3 Dual 2EP Pin Configuration



BVDSS	RDSON	ID
30V	20mΩ	12A
-30V	50mΩ	-8A

## Features

- Fast switching
- Green Device Available
- Suit for 4.5V Gate Drive Applications

## Applications

- DC Fan
- Motor Drive Applications
- Networking
- Half / Full Bridge Topology



## Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating		Units
$V_{DS}$	Drain-Source Voltage	30	-30	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	12	-8	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	7.2	-4.8	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	48	-32	A
EAS	Single Pulse Avalanche Energy <sup>2,6</sup>	14	5	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	17	10	A
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	20		W
	Power Dissipation – Derate above $25^\circ\text{C}$	0.16		W/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150		$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150		$^\circ\text{C}$

## Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62.5	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	6.4	$^\circ\text{C/W}$



STEIF POWER  
TECHNOLOGY

30V N+P Dual Channel MOSFETs

SPC3712V

N-CH Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise)

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=250\mu\text{A}$	30	---	---	V
$I_{\text{DSS}}$	Drain-Source Leakage Current	$V_{\text{DS}}=30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	1	$\mu\text{A}$
		$V_{\text{DS}}=24\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=125^\circ\text{C}$	---	---	10	$\mu\text{A}$
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$

### On Characteristics

$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$ , $I_D=10\text{A}$	---	15	20	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$ , $I_D=6\text{A}$	---	21	30	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D=250\mu\text{A}$	1.2	1.5	2.5	V
			---	-4	---	$\text{mV}/^\circ\text{C}$
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=5\text{V}$ , $I_D=6\text{A}$	---	13	---	S

### Dynamic and switching Characteristics

$Q_g$	Total Gate Charge <sup>3,4</sup>	$V_{\text{DS}}=15\text{V}$ , $V_{\text{GS}}=4.5\text{V}$ , $I_D=8\text{A}$	---	4.1	6	nC
$Q_{\text{gs}}$	Gate-Source Charge <sup>3,4</sup>		---	1	1.4	
$Q_{\text{gd}}$	Gate-Drain Charge <sup>3,4</sup>		---	2.1	4	
$T_{\text{d(on)}}$	Turn-On Delay Time <sup>3,4</sup>	$V_{\text{DD}}=15\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_G=6\Omega$ $I_D=1\text{A}$	---	2.8	5	ns
$T_r$	Rise Time <sup>3,4</sup>		---	7.2	14	
$T_{\text{d(off)}}$	Turn-Off Delay Time <sup>3,4</sup>		---	15.8	30	
$T_f$	Fall Time <sup>3,4</sup>		---	4.6	9	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=25\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $F=1\text{MHz}$	---	345	500	pF
$C_{\text{oss}}$	Output Capacitance		---	55	80	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	32	55	
$R_g$	Gate resistance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=0\text{V}$ , $F=1\text{MHz}$	---	3.2	6.4	$\Omega$

### Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	12	A
$I_{\text{SM}}$	Pulsed Source Current		---	---	24	A
$V_{\text{SD}}$	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$ , $I_s=1\text{A}$ , $T_J=25^\circ\text{C}$	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{\text{DD}}=25\text{V}$ ,  $V_{\text{GS}}=10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{\text{AS}}=17\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\text{us}$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.

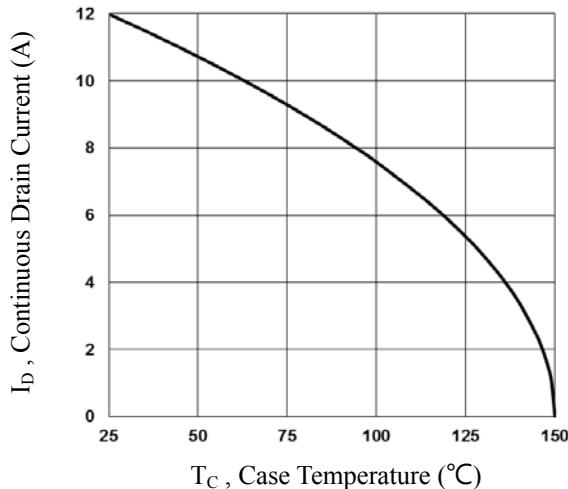


Fig.1 Continuous Drain Current vs.  $T_C$

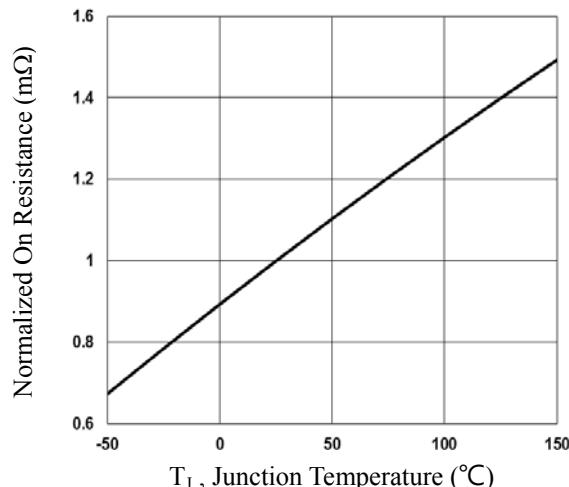


Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_J$

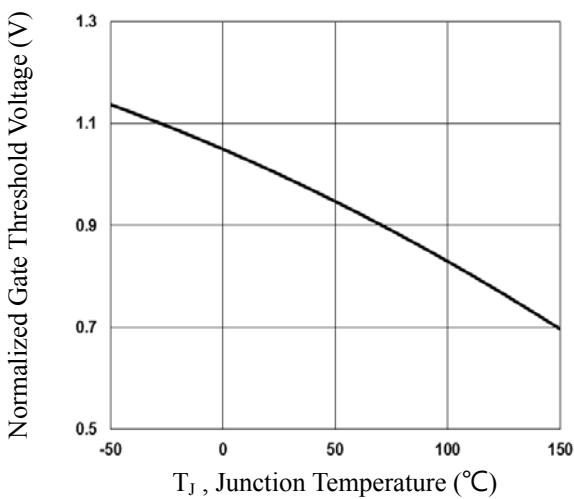


Fig.3 Normalized  $V_{th}$  vs.  $T_J$

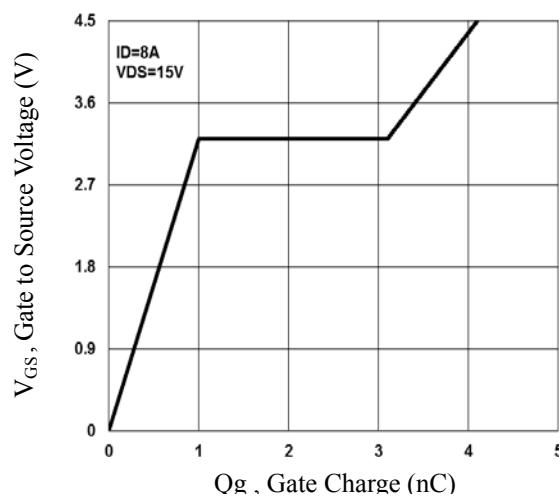


Fig.4 Gate Charge Waveform

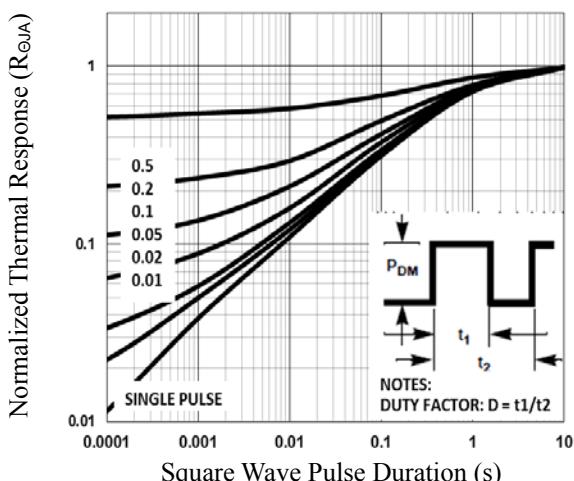


Fig.5 Normalized Transient Response

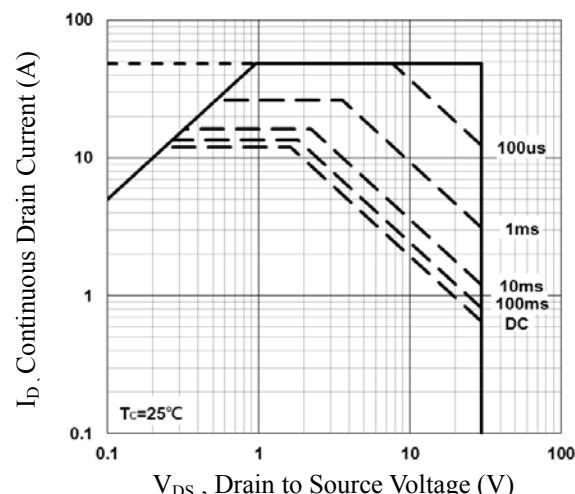


Fig.6 Maximum Safe Operation Area



P-CH Electrical Characteristics ( $T_J=25\text{ }^\circ\text{C}$ , unless otherwise)

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_D=-250\mu\text{A}$	-30	---	---	V
$\Delta BV_{DSS}/\Delta T_J$	$BV_{DSS}$ Temperature Coefficient	Reference to $25\text{ }^\circ\text{C}$ , $I_D=-1\text{mA}$	---	-0.03	---	$\text{V}/\text{ }^\circ\text{C}$
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=-30\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=25\text{ }^\circ\text{C}$	---	---	-1	$\mu\text{A}$
		$V_{DS}=-24\text{V}$ , $V_{GS}=0\text{V}$ , $T_J=125\text{ }^\circ\text{C}$	---	---	-10	$\mu\text{A}$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20\text{V}$ , $V_{DS}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$

### On Characteristics

$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=-10\text{V}$ , $I_D=-5\text{A}$	---	40	50	$\text{m}\Omega$
		$V_{GS}=-4.5\text{V}$ , $I_D=-3\text{A}$	---	60	75	$\text{m}\Omega$
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$ , $I_D=-250\mu\text{A}$	-1.2	-1.6	-2.5	V
			---	4	---	$\text{mV}/\text{ }^\circ\text{C}$
$g_{fs}$	Forward Transconductance	$V_{DS}=-10\text{V}$ , $I_D=-3\text{A}$	---	3.5	---	S

### Dynamic and switching Characteristics

$Q_g$	Total Gate Charge <sup>7,8</sup>	$V_{DS}=-15\text{V}$ , $V_{GS}=-4.5\text{V}$ , $I_D=-3\text{A}$	---	5.1	7	nC
$Q_{gs}$	Gate-Source Charge <sup>7,8</sup>		---	2	3	
$Q_{gd}$	Gate-Drain Charge <sup>7,8</sup>		---	2.2	4	
$T_{d(on)}$	Turn-On Delay Time <sup>7,8</sup>	$V_{DD}=-15\text{V}$ , $V_{GS}=-10\text{V}$ , $R_G=6\Omega$ $I_D=-1\text{A}$	---	3.4	6	ns
$T_r$	Rise Time <sup>7,8</sup>		---	10.8	21	
$T_{d(off)}$	Turn-Off Delay Time <sup>7,8</sup>		---	26.9	51	
$T_f$	Fall Time <sup>7,8</sup>		---	6.9	13	
$C_{iss}$	Input Capacitance		---	560	810	pF
$C_{oss}$	Output Capacitance	$V_{DS}=-15\text{V}$ , $V_{GS}=0\text{V}$ , $f=1\text{MHz}$	---	55	80	
$C_{rss}$	Reverse Transfer Capacitance		---	40	60	

### Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current	$V_G=V_D=0\text{V}$ , Force Current	---	---	-8	A
$I_{SM}$	Pulsed Source Current		---	---	-16	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0\text{V}$ , $I_S=-1\text{A}$ , $T_J=25\text{ }^\circ\text{C}$	---	---	-1	V

Note :

5. Repetitive Rating : Pulsed width limited by maximum junction temperature.
6.  $V_{DD}=-25\text{V}$ ,  $V_{GS}=-10\text{V}$ ,  $L=0.1\text{mH}$ ,  $I_{AS}=-10\text{A}$ ,  $R_G=25\Omega$ , Starting  $T_J=25\text{ }^\circ\text{C}$
7. The data tested by pulsed , pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
8. Essentially independent of operating temperature.

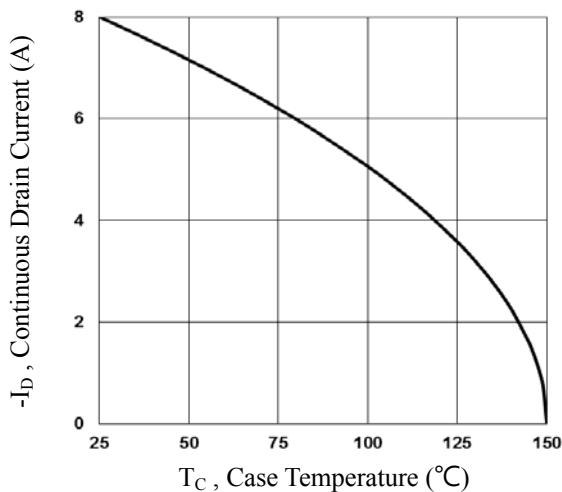


Fig.1 Continuous Drain Current vs.  $T_c$

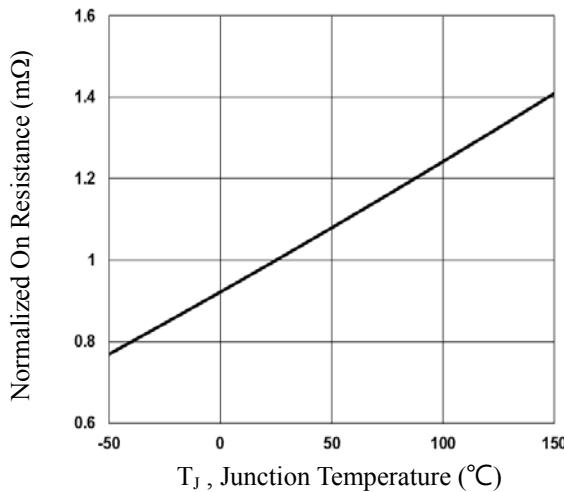


Fig.2 Normalized RD<sub>SON</sub> vs.  $T_j$

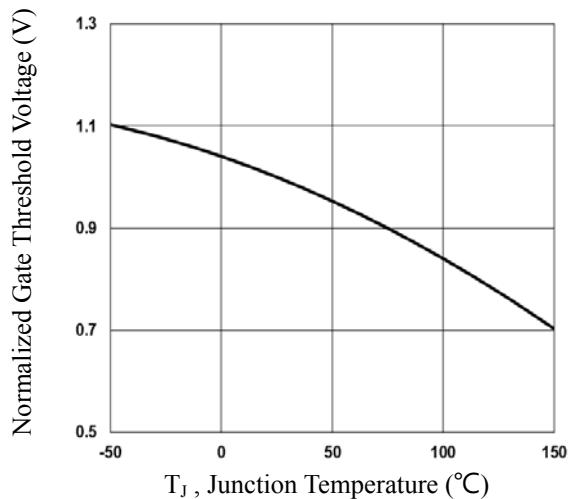


Fig.3 Normalized  $V_{th}$  vs.  $T_j$

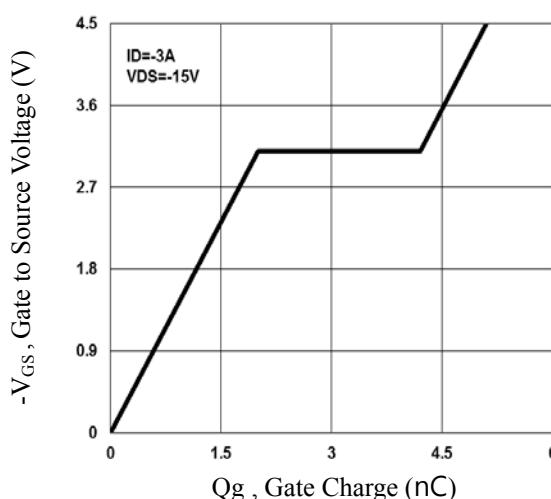


Fig.4 Gate Charge Waveform

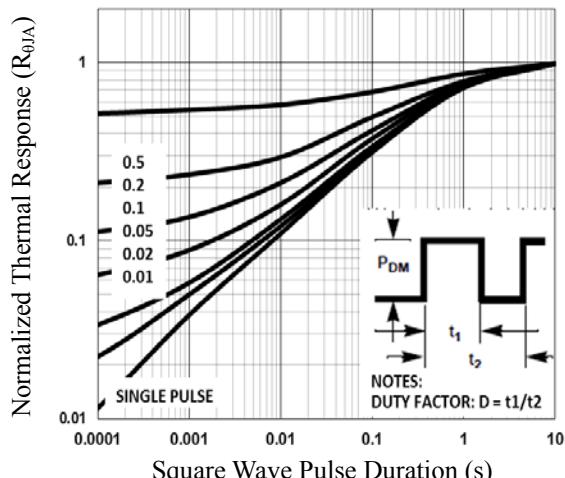


Fig.5 Normalized Transient Impedance

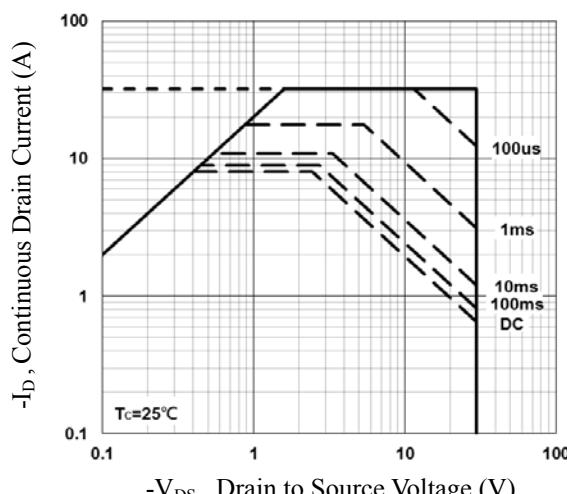
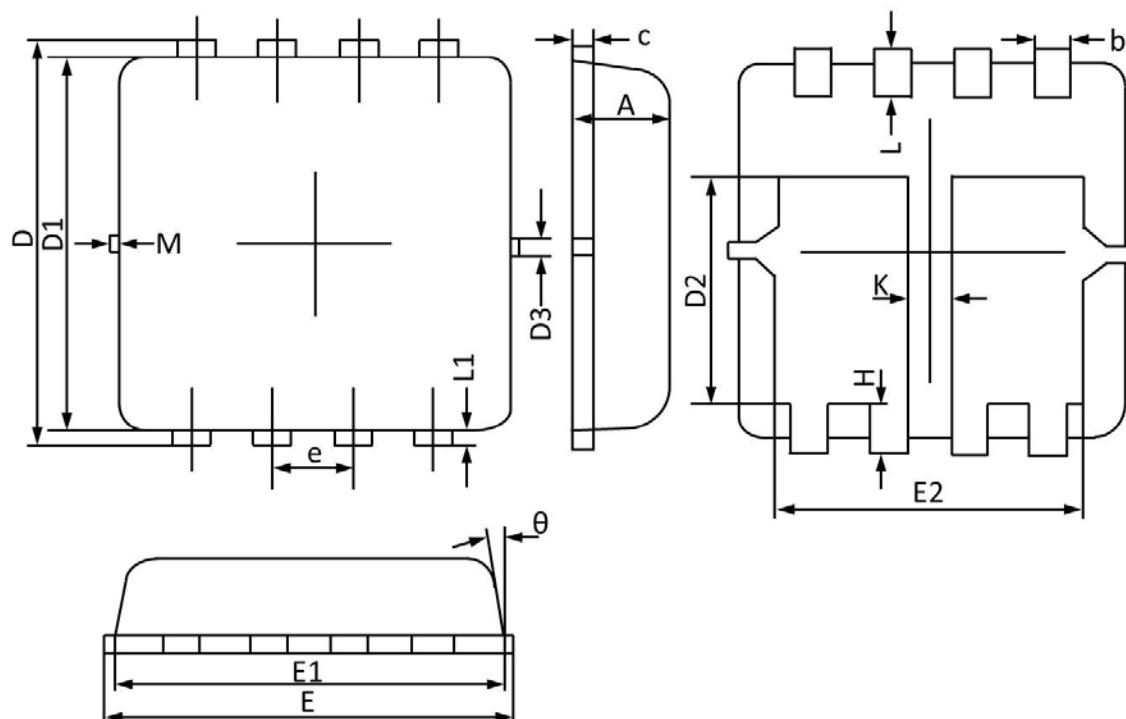


Fig.6 Maximum Safe Operation Area



## PPAK3x3 Dual PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
b	0.250	0.350	0.010	0.013
c	0.100	0.250	0.004	0.009
D	3.250	3.450	0.128	0.135
D1	3.000	3.200	0.119	0.125
D2	1.780	1.980	0.070	0.077
D3	0.130 REF		0.005 REF	
E	3.200	3.400	0.126	0.133
E1	3.000	3.200	0.119	0.125
E2	2.390	2.590	0.094	0.102
e	0.650 BSC		0.026 BSC	
H	0.300	0.500	0.011	0.019
L	0.300	0.500	0.011	0.019
L1	0.130 REF		0.005 REF	
K	0.300 REF		0.012 REF	
θ	0°	12°	0°	12°
M	0.150 REF		0.006 REF	